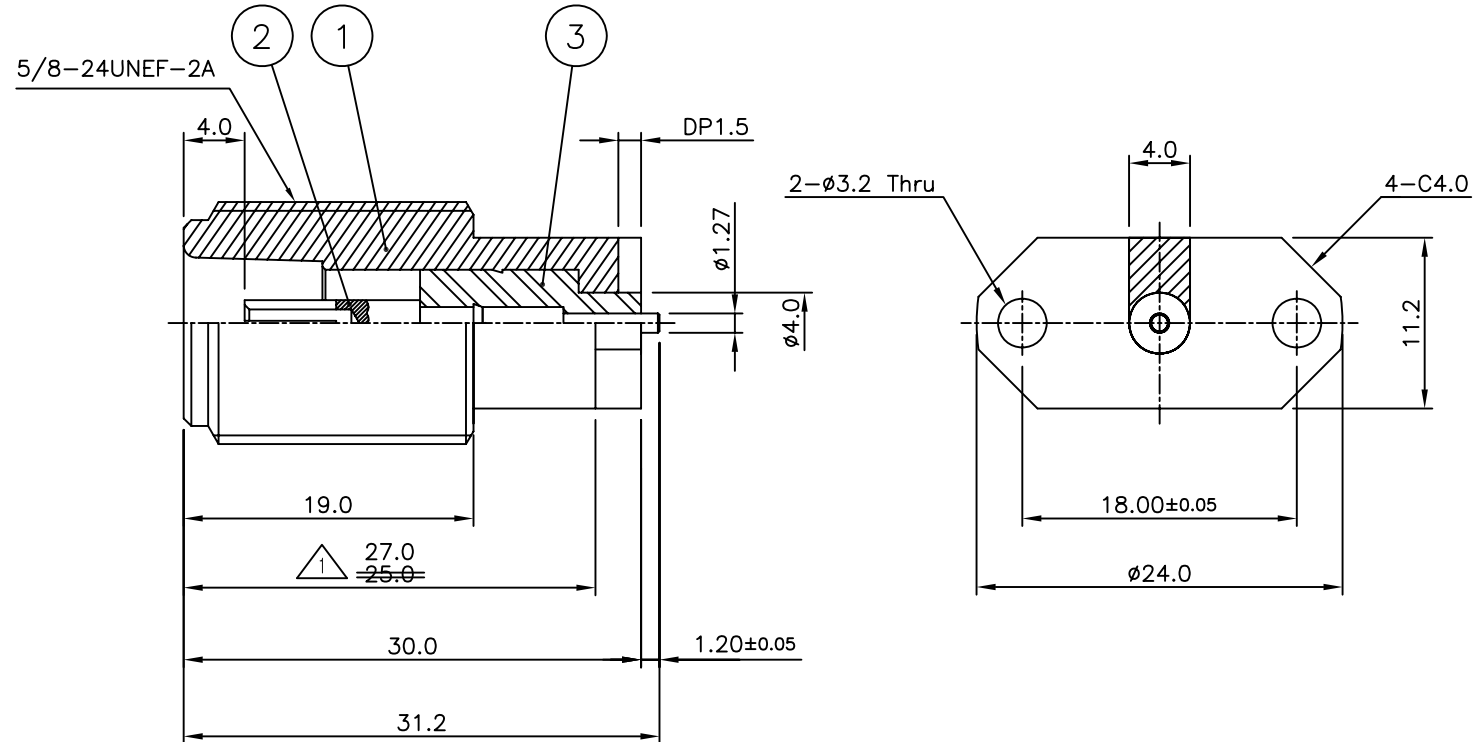


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	C.K.KIM	I.C.KIM	2016. 06. 07.
1	[설변No.201710-0025] 고객사 요청으로 인한 플랜지 두께 변경	S.Y.EUN	I.C.KIM	2017. 10. 27.



3	INSULATOR	1	TEFLON		DIN02778-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03704-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04170-5/2 DBD04170-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2017. 10. 27.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle	APPROVED BY	I.C.KIM				
	$\pm 1^{\circ}$	CHECKED BY			TITLE N50 SOLDER END JS-2H		
MATERIAL	DRAWN BY	S.Y.EUN					
-					DWG NO. CN02877-7/4 REVISION 1 SHEET 1 of 1		
FINISH	SCALE 2/1	UNIT mm		A4			